

### Standard SMD LED PLCC-2



### **DESCRIPTION**

This device has been designed to meet the increasing demand for AllnGaP technology.

The package of the VLMF310. is the PLCC-2 (equivalent to a size B tantalum capacitor).

It consists of a lead frame which is embedded in a white thermoplast. The reflector inside this package is filled up with clear epoxy.

### PRODUCT GROUP AND PACKAGE DATA

Product group: LED
Package: SMD PLCC-2
Product series: standard
Angle of half intensity: ± 60°

### **FEATURES**

- SMD LED with exceptional brightness
- · Luminous intensity categorized
- Compatible with automatic placement equipment



- EIA and ICE standard package
- Compatible with IR reflow, vapor phase and wave solder processes according to CECC 00802 and J-STD-020B
- · Available in 8 mm tape
- · Low profile package
- Non-diffused lens: excellent for coupling to light pipes and backlighting
- Low power consumption
- Luminous intensity ratio in one packaging unit  $I_{Vmax}/I_{Vmin} \leq 1.6$
- · Lead (Pb)-free device
- · Preconditioning: acc. to JEDEC level 2a

### **APPLICATIONS**

- Automotive: backlighting in dashboards and switches
- Telecommunication: indicator and backlighting in telephone and fax
- Indicator and backlight for audio and video equipment
- · Indicator and backlight in office equipment
- Flat backlight for LCDs, switches and symbols
- · General use

PARTS TABLE		
PART	COLOR, LUMINOUS INTENSITY	TECHNOLOGY
VLMF3100-GS08	Soft orange, I <sub>V</sub> > 28 mcd	AllnGaP on GaAs
VLMF3100-GS18	Soft orange, I <sub>V</sub> > 28 mcd	AllnGaP on GaAs
VLMF3101-GS08	Soft orange, $I_V = (45 \text{ to } 112) \text{ mcd}$	AllnGaP on GaAs
VLMF3101-GS18	Soft orange, I <sub>V</sub> = (45 to 112) mcd	AllnGaP on GaAs



ABSOLUTE MAXIMUM RATINGS <sup>1)</sup> VLMF310.					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Reverse voltage <sup>2)</sup>		V <sub>R</sub>	5	V	
DC Forward current	T <sub>amb</sub> ≤ 85 °C	I <sub>F</sub>	30	mA	
Surge forward current	t <sub>p</sub> ≤ 10 μs	I <sub>FSM</sub>	0.1	Α	
Power dissipation		P <sub>V</sub>	80	mW	
Junction temperature		T <sub>j</sub>	125	°C	
Operating temperature range		T <sub>amb</sub>	- 40 to + 100	°C	
Storage temperature range		T <sub>stg</sub>	- 40 to + 100	°C	
Thermal resistance junction/ ambient	mounted on PC board (pad size > 16 mm²)	R <sub>thJA</sub>	400	K/W	

Note:

<sup>1)</sup> T<sub>amb</sub> = 25 °C, unless otherwise specified 2) Driving LED in reverse direction is suitable for short term application

OPTICAL AND ELECTRICAL CHARACTERISTICS <sup>1)</sup> VLMF310., SOFT ORANGE							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN	TYP.	MAX	UNIT
Luminous intensity	I <sub>F</sub> = 10 mA	VLMF3100	I <sub>V</sub>	28	90		mcd
		VLMF3101	I <sub>V</sub>	45		112	mcd
Dominant wavelength	I <sub>F</sub> = 10 mA		$\lambda_{d}$	598	605	611	nm
Peak wavelength	I <sub>F</sub> = 10 mA		$\lambda_{p}$		590		nm
Angle of half intensity	I <sub>F</sub> = 10 mA		φ		± 60		deg
Forward voltage	I <sub>F</sub> = 20 mA		$V_{F}$		2.0	2.6	V
Reverse voltage	I <sub>R</sub> = 10 μA		$V_{R}$	5			V
Junction capacitance	V <sub>R</sub> = 0, f = 1 MHz		C <sub>j</sub>		15		pF

Note:

In one Packing Unit  $I_{Vmax}/I_{Vmin} \le 1.6$   $^{1)}$   $T_{amb}$  = 25  $^{\circ}C,$  unless otherwise specified

LUMINOUS INTENSITY CLASSIFICATION				
GROUP	LIGHT INTENSITY (MCD)			
STANDARD	OPTIONAL	MIN	MAX	
М	1			
IVI	2	22.4	28.0	
N	1	28.0	35.5	
	2	35.5	45	
Р	1	45	56	
Г	2	56	71	
Q	1	71	90	
	2	90	112	
R	1	112	140	
	2	140	180	
S	1	180	224	
	2	224	280	

Note:

Luminous intensity is tested at a current pulse duration of 25 ms and an accuracy of ± 11 %.

The above type numbers represent the order groups which include only a few brightness groups. Only one group will be shipped on each reel (there will be no mixing of two groups on each reel). In order to ensure availability, single brightness groups will not be orderable.

In a similar manner for colors where wavelength groups are measured and binned, single wavelength groups will be shipped on any one reel.

In order to ensure availability, single wavelength groups will not be orderable.

CROSSING TABLE		
VISHAY	OSRAM	
VLMF3100	LOT676	
VLMF3101	LOT676R1S1	

COLOR CLASSIFICATION				
	SOFT ORANGE			
GROUP	GROUP DOM. WAVELENGTH (			
	MIN.	MAX.		
1	598	601		
2	600	603		
3	602	605		
4	604	607		
5	606	609		
6	608	611		





### **TYPICAL CHARACTERISTICS**

T<sub>amb</sub> = 25 °C, unless otherwise specified

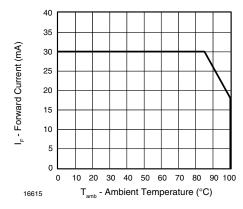


Figure 1. Forward Current vs. Ambient Temperature for InGaN

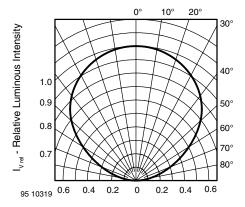


Figure 2. Rel. Luminous Intensity vs. Angular Displacement

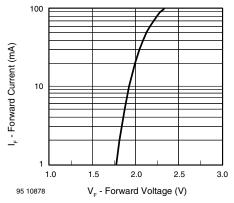


Figure 3. Forward Current vs. Forward Voltage

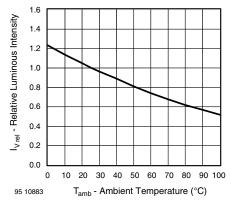


Figure 4. Rel. Luminous Intensity vs. Ambient Temperature

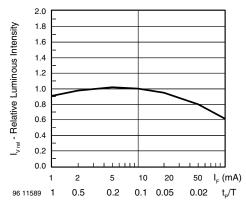


Figure 5. Rel. Lumin. Intensity vs. Forw. Current/Duty Cycle

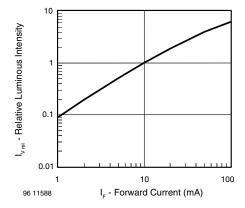


Figure 6. Relative Luminous Intensity vs. Forward Current



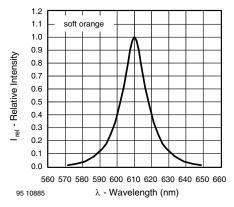


Figure 7. Relative Intensity vs. Wavelength

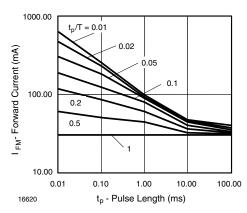


Figure 9. Forward Current vs. Pulse Length

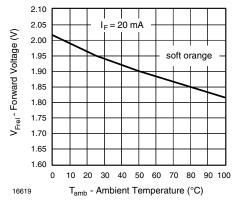
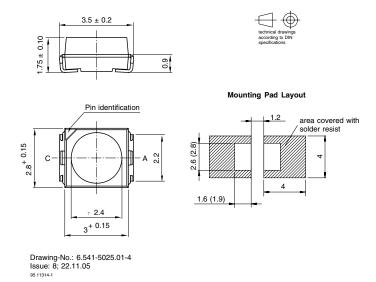


Figure 8. Forward Voltage vs. Ambient Temperature

### **PACKAGE DIMENSIONS** in millimeters

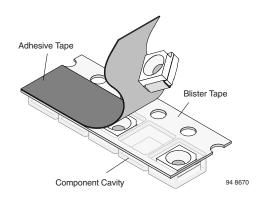




### METHOD OF TAPING/POLARITY AND TAPE AND REEL

### **SMD LED (VLM3 - SERIES)**

Vishay's LEDs in SMD packages are available in an antistatic 8 mm blister tape (in accordance with DIN IEC 40 (CO) 564) for automatic component insertation. The blister tape is a plastic strip with impressed component cavaties, covered by a top tape.



### **TAPING OF VLM.3..**

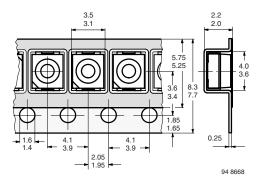


Figure 10. Tape Dimensions in mm for PLCC-2

# REEL PACKAGE DIMENSION IN MM FOR SMD LEDS, TAPE OPTION GS08 (= 1500 PCS.)

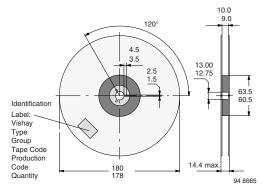


Figure 11. Reel Dimensions - GS08

# REEL PACKAGE DIMENSION IN MM FOR SMD LEDS, TAPE OPTION GS18 (= 8000 PCS.) PREFERRED

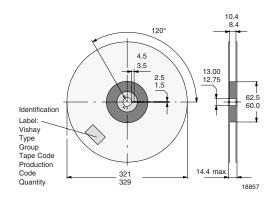


Figure 12. Reel Dimensions - GS18

### **SOLDERING PROFILE**

IR Reflow Soldering Profile for lead (Pb)-free soldering Preconditioning acc. to JEDEC Level 2a

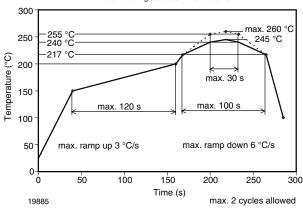


Figure 13. Vishay Leadfree Reflow Soldering Profile (acc. to J-STD-020B)

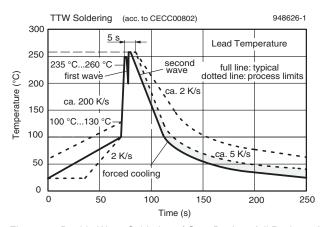
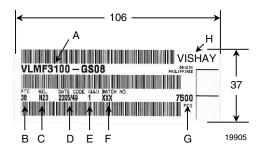


Figure 14. Double Wave Soldering of Opto Devices (all Packages)

# BAR CODE PRODUCT LABEL EXAMPLE:



- A) Type of component
- B) Manufacturing Plant
- C) SEL selection code (bin):

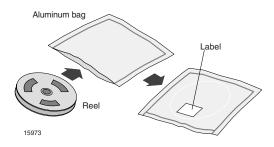
e.g.: N2 = code for luminous intensity group

3 = code for color group

- D) Date code year/week
- E) Day code (e. g. 1: Monday)
- F) Batch no.
- G) Total quantity
- H) Company code

### **DRY PACKING**

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



### **FINAL PACKING**

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.



#### **RECOMMENDED METHOD OF STORAGE**

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 672 h under these conditions moisture content will be too high for reflow soldering.

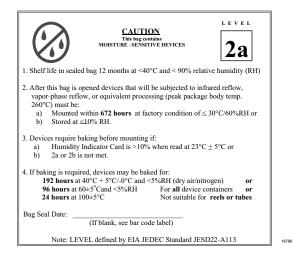
In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C/- 0 °C and < 5 % RH (dry air/ nitrogen) or

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 100 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC Standard JESD22-A112 level 2a label is included on all dry bags.



Example of JESD22-A112 level 2a label

### **ESD PRECAUTION**

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electro-static sensitive devices warning labels are on the packaging.

# VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



#### **OZONE DEPLETING SUBSTANCES POLICY STATEMENT**

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

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Vishay

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